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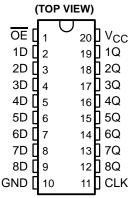
# Jameco Part Number 291557

# ₹155 / SN54ABT574, SN74ABT574A OCTAL EDGE-TRIGGERED D-TYPE FLIP-FLOPS WITH 3-STATE OUTPUTS

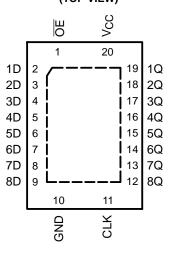
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- Typical V<sub>OLP</sub> (Output Ground Bounce) <1 V at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C
- High-Drive Outputs (–32-mA I<sub>OH</sub>, 64-mA I<sub>OL</sub>)
- I<sub>off</sub> Supports Partial-Power-Down Mode Operation
- Latch-Up Performance Exceeds 500 mA Per JEDEC Standard JESD 17
- ESD Protection Exceeds JESD 22
  - 2000-V Human-Body Model (A114-A)
  - 200-V Machine Model (A115-A)

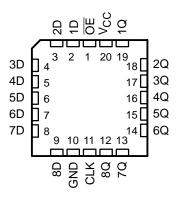
SN54ABT574...J OR W PACKAGE SN74ABT574A...DB, DW, N, NS, OR PW PACKAGE



SN74ABT574A . . . RGY PACKAGE (TOP VIEW)



SN54ABT574 . . . FK PACKAGE (TOP VIEW)



### description/ordering information

These 8-bit flip-flops feature 3-state outputs designed specifically for driving highly capacitive or relatively low-impedance loads. They are particularly suitable for implementing buffer registers, I/O ports, bidirectional bus drivers, and working registers.

The eight flip-flops of the SN54ABT574 and SN74ABT574A are edge-triggered D-type flip-flops. On the positive transition of the clock (CLK) input, the Q outputs are set to the logic levels set up at the data (D) inputs.

#### **ORDERING INFORMATION**

| TA             | PACKA       | GE†                        | ORDERABLE<br>PART NUMBER | TOP-SIDE<br>MARKING |
|----------------|-------------|----------------------------|--------------------------|---------------------|
|                | PDIP – N    | Tube                       | SN74ABT574AN             | SN74ABT574AN        |
|                | QFN – RGY   | Tape and reel              | SN74ABT574ARGYR          | AB574A              |
|                | SOIC DW     | DIC - DW Tube SN74ABT574A  |                          | ABT574A             |
| -40°C to 85°C  | 301C - DVV  | Tape and reel              | SN74ABT574ADWR           | AB1374A             |
| -40 C to 65 C  | SOP – NS    | Tape and reel              | SN74ABT574ANSR           | ABT574A             |
|                | SSOP – DB   | Tape and reel              | SN74ABT574ADBR           | AB574A              |
|                | TSSOP – PW  | Tape and reel              | SN74ABT574APWR           | AB574A              |
|                | VFBGA – GQN | Tape and reel              | SN74ABT574AGQNR          | AB574A              |
|                | CDIP – J    | CDIP – J Tube SNJ54ABT574J |                          | SNJ54ABT574J        |
| –55°C to 125°C | CFP – W     | Tube                       | SNJ54ABT574W             | SNJ54ABT574W        |
|                | LCCC – FK   | Tube                       | SNJ54ABT574FK            | SNJ54ABT574FK       |

<sup>†</sup> Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



# SN54ABT574, SN74ABT574A OCTAL EDGE-TRIGGERED D-TYPE FLIP-FLOPS WITH 3-STATE OUTPUTS

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## description/ordering information (continued)

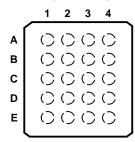
A buffered output-enable  $(\overline{OE})$  input can be used to place the eight outputs in either a normal logic state (high or low logic levels) or the high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state and increased drive provide the capability to drive bus lines without need for interface or pullup components.

OE does not affect the internal operations of the flip-flops. Old data can be retained or new data can be entered while the outputs are in the high-impedance state.

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

This device is fully specified for partial-power-down applications using I<sub>off</sub>. The I<sub>off</sub> circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

# SN74ABT574A . . . GQN PACKAGE (TOP VIEW)



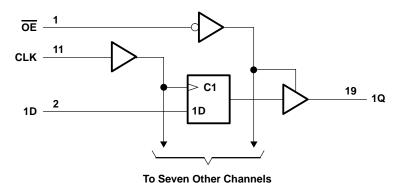
# terminal assignments

|   | 1   | 2     | 3   | 4  |
|---|-----|-------|-----|----|
| Α | 1D  | OE    | Vcc | 1Q |
| В | 3D  | 3D 3Q |     | 2Q |
| С | 5D  | 4D    | 5Q  | 4Q |
| D | 7D  | 7Q    | 6D  | 6Q |
| Ε | GND | 8D    | CLK | 8Q |

# FUNCTION TABLE (each flip-flop)

|    | INPUTS     |   | OUTPUT         |
|----|------------|---|----------------|
| OE | CLK        | D | Q              |
| L  | 1          | Н | Н              |
| L  | $\uparrow$ | L | L              |
| L  | H or L     | Χ | Q <sub>0</sub> |
| Н  | Χ          | Χ | Z              |

#### logic diagram (positive logic)



Pin numbers shown are for the DB, DW, FK, J, N, NS, PW, RGY, and W packages.



# SN54ABT574, SN74ABT574A OCTAL EDGE-TRIGGERED D-TYPE FLIP-FLOPS WITH 3-STATE OUTPUTS

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## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

| Supply voltage range, V <sub>CC</sub>                                  | –0.5 V to 7 V   |
|--|-----------------|
| Input voltage range, V <sub>I</sub> (see Note 1)                       |                 |
| Voltage range applied to any output in the high or power-off state, VO | –0.5 V to 5.5 V |
| Current into any output in the low state, IO: SN54ABT574               | 96 mA           |
| SN74ABT574A  |                 |
| Input clamp current, I <sub>IK</sub> (V <sub>I</sub> < 0)              | –18 mA          |
| Output clamp current, I <sub>OK</sub> (V <sub>O</sub> < 0)             |                 |
| Package thermal impedance, θ <sub>JA</sub> (see Note 2): DB package    | 70°C/W          |
| (see Note 2): DW package   | 58°C/W          |
| (see Note 2): GQN package  | 78°C/W          |
| (see Note 2): N package  | 69°C/W          |
| (see Note 2): NS package   | 60°C/W          |
| (see Note 2): PW package   | 83°C/W          |
| (see Note 3): RGY package  | 37°C/W          |
| Storage temperature range, T <sub>stq</sub>                            | –65°C to 150°C  |

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
  - 2. The package thermal impedance is calculated in accordance with JESD 51-7.
  - 3. The package thermal impedance is calculated in accordance with JESD 51-5.

# recommended operating conditions (see Note 4)

|  |   |                 | SN54A       | BT574 | SN74AB | T574A | UNIT |
|--|---|-----------------|-------------|-------|--------|-------|------|
|  |   |                 | MIN         | MAX   | MIN    | MAX   | UNIT |
| Vcc                                      | Supply voltage                          |                 | 4.5         | 5.5   | 4.5    | 5.5   | V    |
| V <sub>IH</sub> High-level input voltage |   | 2               |             | 2     |        | V     |      |
| V <sub>IL</sub>                          | V <sub>IL</sub> Low-level input voltage |                 |             | 0.8   |        | 0.8   | V    |
| ٧ <sub>I</sub>                           | / <sub>I</sub> Input voltage            |                 | 0           | VCC   | 0      | VCC   | V    |
| ЮН                                       | High-level output current               |                 |             | -24   |        | -32   | mA   |
| loL                                      | Low-level output current                |                 |             | 48    |        | 64    | mA   |
| Δt/Δν                                    | Input transition rise or fall rate      | Outputs enabled |             | 5     |        | 5     | ns/V |
| TA                                       | Operating free-air temperature          |                 | <b>-</b> 55 | 125   | -40    | 85    | °C   |

NOTE 4: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



# **SN54ABT574, SN74ABT574A OCTAL EDGÉ-TRIGGERED D-TYPE FLIP-FLOPS** WITH 3-STATE OUTPUTS

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## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| BARAMETER        |   | TEGT COMPLETO                                | NO               | Т   | A = 25°C         | ;                | SN54ABT574 |                  | SN74ABT574A |                  | LINUT |
|------------------|---|--|------------------|-----|------------------|------------------|------------|------------------|-------------|------------------|-------|
| PARAMETER        |   | TEST CONDITIONS                              |                  | MIN | TYP <sup>†</sup> | MAX              | MIN        | MAX              | MIN         | MAX              | UNIT  |
| VIK              | $V_{CC} = 4.5 \text{ V},$   | $I_{I} = -18 \text{ mA}$                     |                  |     |                  | -1.2             |            | -1.2             |             | -1.2             | V     |
|                  | $V_{CC} = 4.5 \text{ V},$   | $I_{OH} = -3 \text{ mA}$                     |                  | 2.5 |                  |                  | 2.5        |                  | 2.5         |                  |       |
| V                | $V_{CC} = 5 V$ ,  | $I_{OH} = -3 \text{ mA}$                     |                  | 3   |                  |                  | 3          |                  | 3           |                  | V     |
| VOH              | V <sub>CC</sub> = 4.5 V   | $I_{OH} = -24 \text{ mA}$                    |                  | 2   |                  |                  | 2          |                  |             |                  | V     |
|                  | VCC = 4.5 V   | $I_{OH} = -32 \text{ mA}$                    |                  | 2*  |                  |                  |            |                  | 2           |                  |       |
| Voi              | V <sub>CC</sub> = 4.5 V   | $I_{OL} = 48 \text{ mA}$                     |                  |     |                  | 0.55             |            | 0.55             |             |                  | V     |
| VOL              | VCC = 4.5 V   | I <sub>OL</sub> = 64 mA                      |                  |     |                  | 0.55*            |            |                  |             | 0.55             | V     |
| $V_{hys}$        |   |  |                  |     | 100              |                  |            |                  |             |                  | mV    |
| lį               | $V_{CC} = 5.5 \text{ V},  V_I = V_{CC} \text{ or GND}$              |  |                  |     | ±1               |                  | ±1         |                  | ±1          | μΑ               |       |
| lozh             | $V_{CC} = 5.5 \text{ V},$   | $V_0 = 2.7 \text{ V}$                        |                  |     |                  | 10‡              |            | 10‡              |             | 10‡              | μΑ    |
| lozL             | $V_{CC} = 5.5 \text{ V},$   | $V_0 = 0.5 V$                                |                  |     |                  | -10 <sup>‡</sup> |            | -10 <sup>‡</sup> |             | -10 <sup>‡</sup> | μΑ    |
| l <sub>off</sub> | $V_{CC} = 0$ ,  | $V_I$ or $V_O \le 4.5 \text{ V}$             | '                |     |                  | ±100             |            | ±500             |             | ±100             | μΑ    |
| ICEX             | $V_{CC} = 5.5 \text{ V},$   | $V_0 = 5.5 \text{ V}$                        | Outputs high     |     |                  | 50               |            | 50               |             | 50               | μΑ    |
| ΙΟ§              | $V_{CC} = 5.5 \text{ V},$   | $V_0 = 2.5 \text{ V}$                        |                  | -50 | -100             | -180             | -50        | -180             | -50         | -180             | mA    |
|                  | .,,   |  | Outputs high     |     | 1                | 250              |            | 250              |             | 250              | μΑ    |
| lcc              | $V_{CC} = 5.5 \text{ V}, \text{ IC}$ $V_{I} = V_{CC} \text{ or GN}$ |  | Outputs low      |     | 24               | 30               |            | 30               |             | 30               | mA    |
|                  | V  = V() 01 014B  |  | Outputs disabled |     | 0.5              | 250              |            | 250              |             | 250              | μΑ    |
| ΔICC¶            | V <sub>CC</sub> = 5.5 V, O<br>Other inputs at                       | ne input at 3.4 V,<br>V <sub>CC</sub> or GND |                  |     |                  | 1.5              |            | 1.5              |             | 1.5              | mA    |
| Ci               | V <sub>I</sub> = 2.5 V or 0.5 V                                     |  |                  | 3.5 |                  |                  |            |                  |             | pF               |       |
| Co               | $V_0 = 2.5 \text{ V or } 0$   | ).5 V  |                  |     | 6.5              |                  |            |                  |             |                  | pF    |

<sup>\*</sup> On products compliant to MIL-PRF-38535, this parameter does not apply.

### timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 1)

|                                    |                                 |             | SN54ABT574        |                |         |     |      |
|------------------------------------|---------------------------------|-------------|-------------------|----------------|---------|-----|------|
|                                    |                                 |             | V <sub>CC</sub> = | = 5 V,<br>25°C | MIN MAX |     | UNIT |
|                                    |                                 | MIN MAX     |                   | MAX            | 1       |     |      |
| f <sub>clock</sub> Clock frequency |                                 |             | 150               |                | 150     | MHz |      |
| t <sub>W</sub>                     | Pulse duration, CLK high or low |             | 3.3               |                | 3.3     |     | ns   |
|                                    | Setup time, data before CLK↑    | High        | 1.5               |                | 1.5     |     | ns   |
| t <sub>su</sub>                    | Setup time, data before CERT    | Low         | 2                 |                | 2       |     |      |
| t <sub>h</sub>                     | Hold time, data after CLK↑      | High or low | 2                 |                | 2       | ·   | ns   |



<sup>†</sup> All typical values are at V<sub>CC</sub> = 5 V. ‡ This data sheet limit may vary among suppliers.

<sup>§</sup> Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

<sup>¶</sup> This is the increase in supply current for each input that is at the specified TTL voltage level rather than V<sub>CC</sub> or GND.

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# timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 1)

|                 |                                    |             |                   | SN74AE         | 3T574A  |     |      |
|-----------------|------------------------------------|-------------|-------------------|----------------|---------|-----|------|
|                 |                                    |             | V <sub>CC</sub> = | = 5 V,<br>25°C | MIN MAX |     | UNIT |
|                 |                                    |             | MIN               | MAX            |         |     |      |
| fclock          | f <sub>clock</sub> Clock frequency |             |                   | 150            |         | 150 | MHz  |
| t <sub>W</sub>  | Pulse duration, CLK high or low    |             | 3.3               |                | 3.3     |     | ns   |
| t               | Setup time data before CLIVA       | High        | 1                 |                | 1       |     | ns   |
| t <sub>su</sub> | Setup time, data before CLK↑       | Low         | 1.5               |                | 1.5     |     | 115  |
| th              | Hold time, data after CLK↑         | High or low | 1.8†              |                | 1.8†    |     | ns   |

<sup>†</sup> This data-sheet limit may vary among suppliers.

# switching characteristics over recommended ranges of supply voltage and operating free-air temperature, $C_L = 50$ pF (unless otherwise noted) (see Figure 1)

|                  |                 |                | SN54ABT574                                      |     |     |     |     |      |
|------------------|-----------------|----------------|---|-----|-----|-----|-----|------|
| PARAMETER        | FROM<br>(INPUT) | TO<br>(OUTPUT) | V <sub>CC</sub> = 5 V,<br>T <sub>A</sub> = 25°C |     |     | MIN | MAX | UNIT |
|                  |                 |                | MIN   | TYP | MAX |     |     |      |
| fmax             |                 |                | 150   | 200 |     | 150 |     | MHz  |
| <sup>t</sup> PLH | CLK             | Q              | 2.2   | 3.9 | 6.2 | 2.2 | 7   | ns   |
| <sup>t</sup> PHL | OLK             | CLIN           | 3   | 4.8 | 7   | 3   | 7.4 | 115  |
| <sup>t</sup> PZH | ŌĒ              | Q              | 1   | 3.3 | 5   | 1   | 5.8 | 20   |
| t <sub>PZL</sub> | OE              | Q              | 2.5   | 4.7 | 5.9 | 2.5 | 7.2 | ns   |
| <sup>t</sup> PHZ | ŌĒ              | Q              | 2.4   | 4.9 | 6.2 | 2.4 | 7.2 | ns   |
| t <sub>PLZ</sub> | OE .            | ١              | 2   | 4   | 5.8 | 2   | 6.9 | 115  |

# switching characteristics over recommended ranges of supply voltage and operating free-air temperature, $C_L = 50$ pF (unless otherwise noted) (see Figure 1)

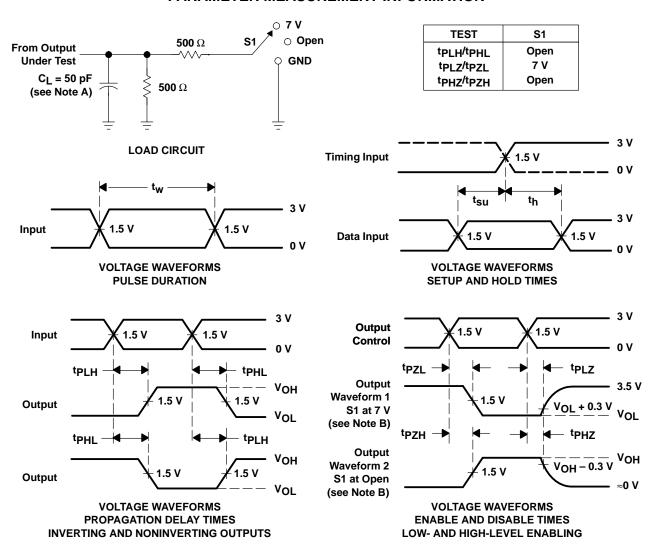
| PARAMETER        | FROM<br>(INPUT) | TO<br>(OUTPUT) | V <sub>CC</sub> = 5 V,<br>T <sub>A</sub> = 25°C |     |     | MIN MA |     | UNIT |
|------------------|-----------------|----------------|---|-----|-----|--------|-----|------|
|                  |                 |                | MIN   | TYP | MAX |        |     |      |
| fmax             |                 |                | 150   | 200 |     | 150    |     | MHz  |
| <sup>t</sup> PLH | CLK             | Q              | 2.2   | 3.9 | 6.2 | 2.2    | 6.8 | ns   |
| <sup>t</sup> PHL | OLK             | ά              | 3   | 4.8 | 6.6 | 3      | 7.1 | 115  |
| <sup>t</sup> PZH | <del></del>     | Q              | 1   | 3.3 | 4.3 | 1      | 5.1 | ns   |
| t <sub>PZL</sub> | ŌĒ              | ά              | 2.1†  | 4.7 | 5.9 | 2.1†   | 6.7 | 115  |
| <sup>t</sup> PHZ | ŌĒ              | Q              | 2.4   | 4.9 | 6.2 | 2.4    | 7   | ns   |
| <sup>t</sup> PLZ | UE UE           | ζ              | 2   | 4   | 5.8 | 2      | 6.5 | 113  |

<sup>†</sup>This data-sheet limit may vary among suppliers.



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#### PARAMETER MEASUREMENT INFORMATION



NOTES: A. C<sub>L</sub> includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_O = 50~\Omega$ ,  $t_f \leq$  2.5 ns,  $t_f \leq$  2.5 ns.
- D. The outputs are measured one at a time with one transition per measurement.
- E. All parameters and waveforms are not applicable to all devices.

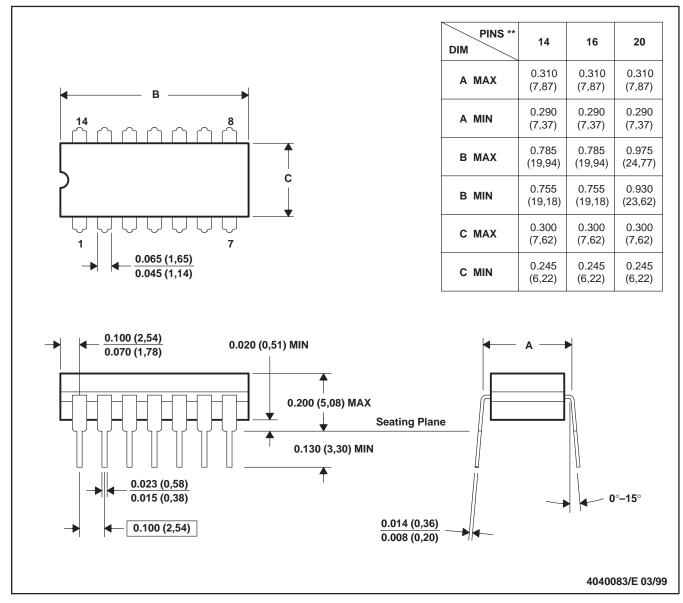
Figure 1. Load Circuit and Voltage Waveforms



### J (R-GDIP-T\*\*)

#### 14 LEADS SHOWN

### **CERAMIC DUAL-IN-LINE**



NOTES: A. All linear dimensions are in inches (millimeters).

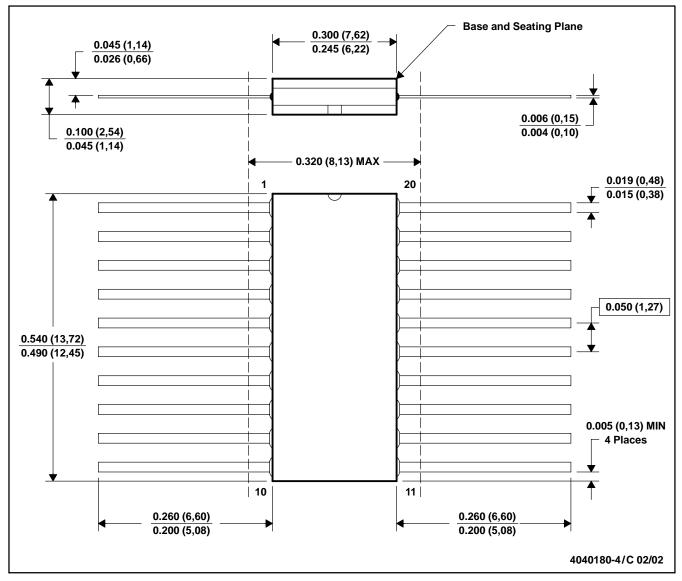
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, and GDIP1-T20



## W (R-GDFP-F20)

#### **CERAMIC DUAL FLATPACK**

1



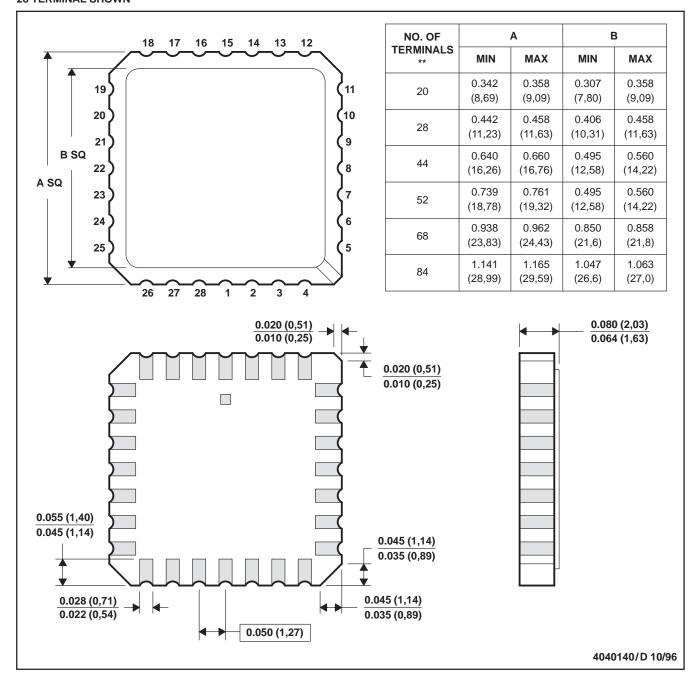
NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.

#### FK (S-CQCC-N\*\*)

#### **28 TERMINAL SHOWN**

#### **LEADLESS CERAMIC CHIP CARRIER**

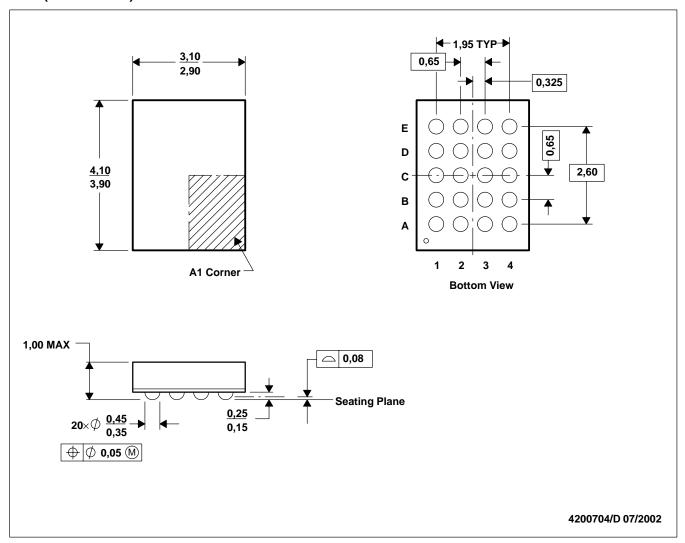


- NOTES: A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package can be hermetically sealed with a metal lid.
  - D. The terminals are gold plated.
  - E. Falls within JEDEC MS-004



# GQN (R-PBGA-N20)

#### **PLASTIC BALL GRID ARRAY**



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. MicroStar Junior™ configuration

D. Falls within JEDEC MO-225 variation BC.

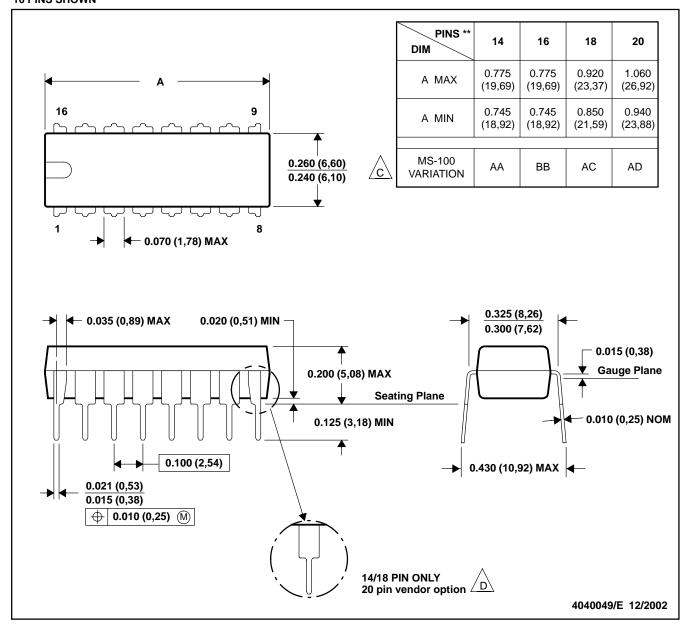
E. This package is tin-lead (SnPb). Refer to the 20 ZQN package (drawing 4204492) for lead-free.

MicroStar Junior is a trademark of Texas Instruments.

### N (R-PDIP-T\*\*)

# 16 PINS SHOWN

#### PLASTIC DUAL-IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

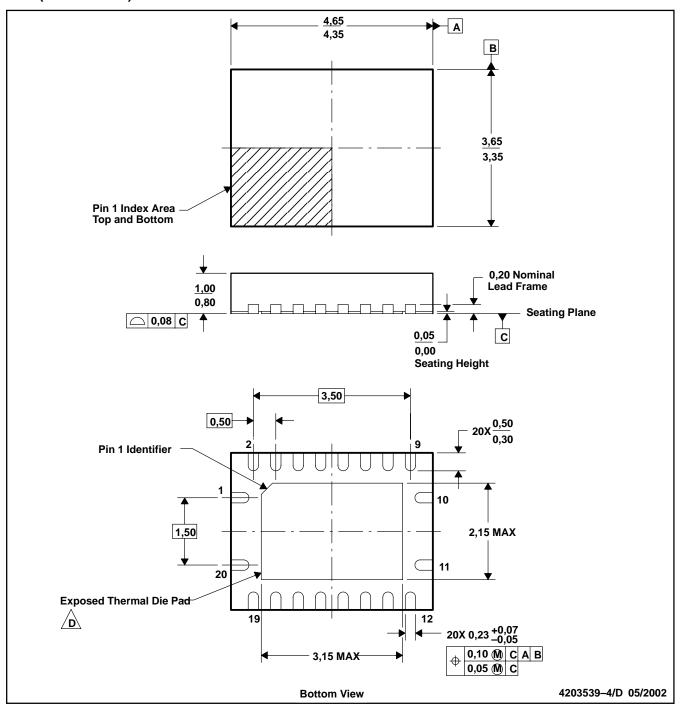
Falls within JEDEC MS-001, except 18 and 20 pin minimum body Irngth (Dim A).

The 20 pin end lead shoulder width is a vendor option, either half or full width.



# RGY (S-PQFP-N20)

#### PLASTIC QUAD FLATPACK



NOTES: A. All linear dimensions are in millimeters.

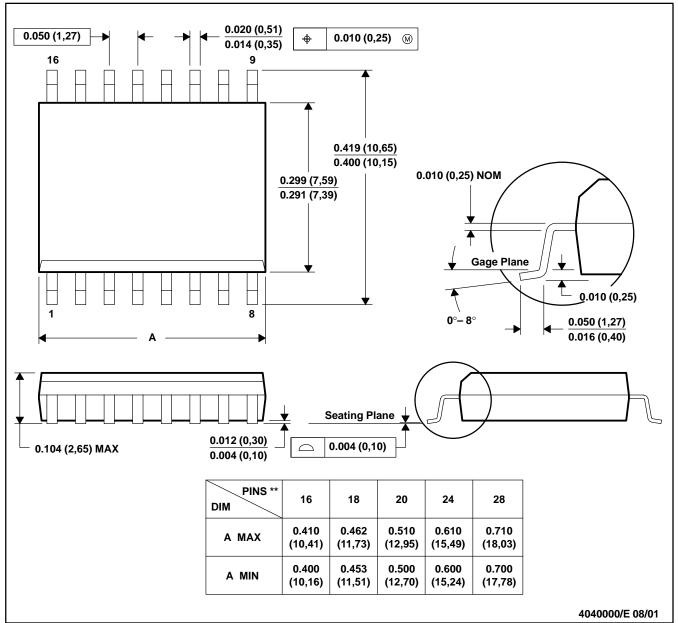
- B. This drawing is subject to change without notice.
- C. QFN (Quad Flatpack No-Lead) Package configuration.
- D. The Package thermal performance may be enhanced by bonding the thermal die pad to an external thermal plane. This pad is electrically and thermally connected to the backside of the die and possibly selected ground leads.



### DW (R-PDSO-G\*\*)

#### PLASTIC SMALL-OUTLINE PACKAGE

#### **16 PINS SHOWN**



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

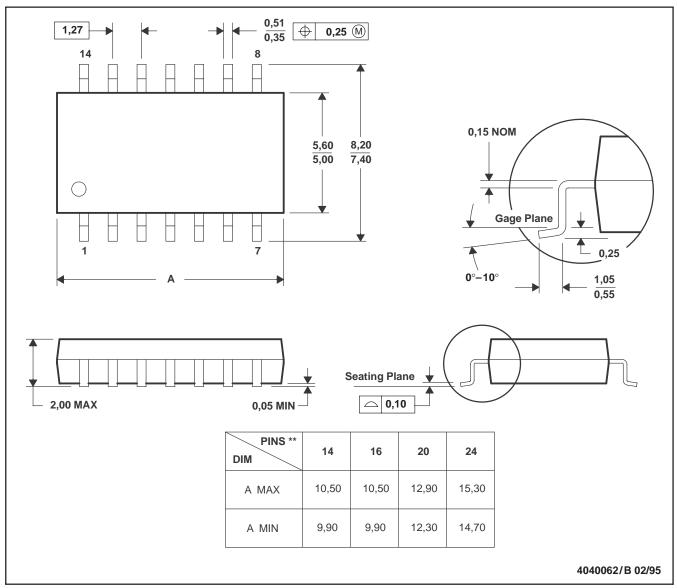
D. Falls within JEDEC MS-013

1

# NS (R-PDSO-G\*\*)

# PLASTIC SMALL-OUTLINE PACKAGE

#### 14 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

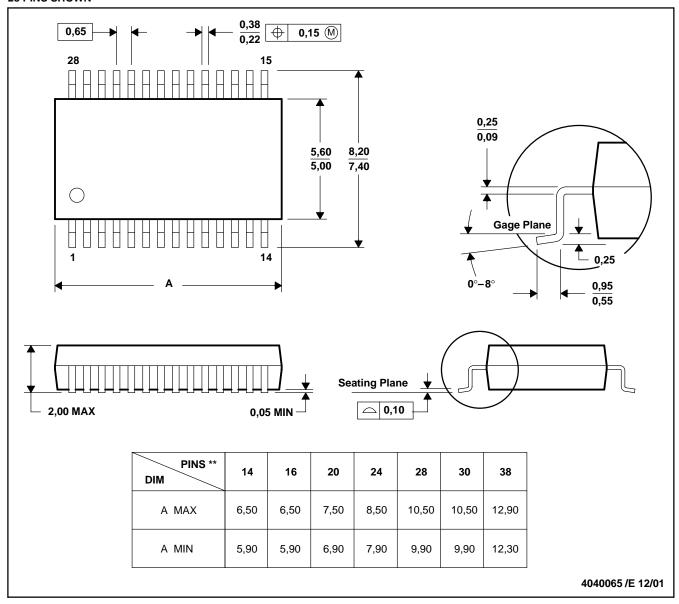
B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

# DB (R-PDSO-G\*\*)

# PLASTIC SMALL-OUTLINE

#### **28 PINS SHOWN**



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

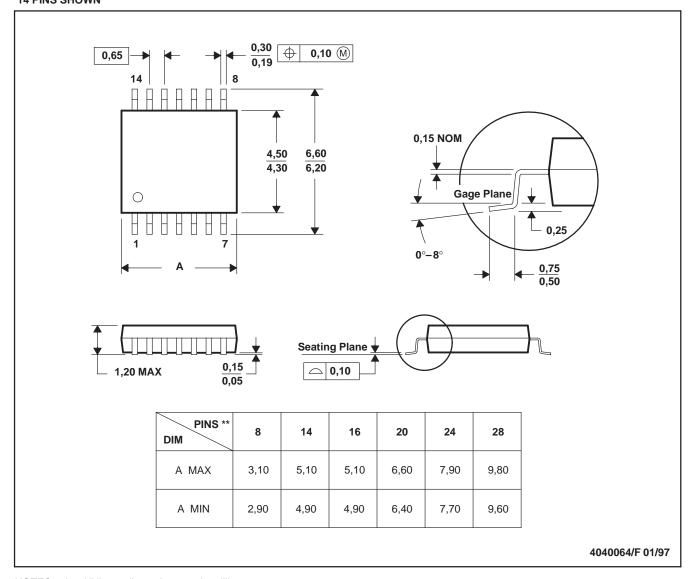
C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-150

# PW (R-PDSO-G\*\*)

#### 14 PINS SHOWN

#### PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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